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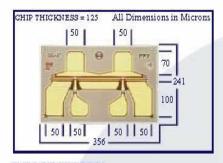




26 GHz Medium Power GaAs FET



DOWNLOAD ADDITIONAL DATA WWW.MWTINC.COM



FEATURES

- +20 dBm OUTPUT POWER AT 12 GHz
- EXCELLENT FOR BROADBAND GAIN OR OSCILLATOR APPLICATIONS
- 0.3 MICRON REFRACTORY METAL/GOLD GATE
- 250 MICRON GATE WIDTH
- CHOICE OF CHIP AND TWO PACKAGE TYPES

PARAMETER

DESCRIPTION

The MwT-7 is a GaAs MESFET device whose nominal quarter-micron gate length and 250 micron gate width make it ideally suited to applications requiring high-gain and medium power in the 500 MHz to 26 GHz frequency range. The straight geometry of the MwT-7 makes it equally effective for either wideband (e.g. 6 to 18 GHz) or narrow-band applications. Processing which guarantees low phase noise makes the MwT-7 particularly attractive for oscillator applications. The chip is produced using MwT's reliable metal system and devices from each wafer are screened to insure reliability. All chips are passivated using MwT's patented "Diamond-Like Carbon" process for increased durability, Designers can use MwT's unique BIN selection feature to choose devices from narrow Idss ranges, insuring consistent circuit operation.

DC SPECIFICATIONS AT Ta = 25°C

SYMBOL	PARAM. & CONDITIONS	UNITS	MIN	TYP	MAX
IDSS	Saturated Drain Current Vds= 4.0 V VGS= 0.0 V	mA	26		98
Gm	Transconductance Vds= 2.0 V VGS= 0.0 V	mS	36	45	
Vp	Pinch-off Voltage Vds= 3.0 V IDS= 5.0 mA	v		-1.5	-4.5
BVGSO	Gate-to-Source Breakdown Volt. Igs= -1.0 m.A.	v	-5.0	-8.0	
BVGDO	Gate-to-Drain Breakdown Volt. Igd= -1.0 m.A	v	- 6 .0	-8.0	
Rth	Thermal MwT-7 Chip, Resistance MwT-770,773 *Overall Rth depends on case mounti	°C/W			180 380*

RF SPECIFICATIONS AT Ta = 25°C

SYMBOL	PARAMETERS AND CONDITIONS	FREQ	UNITS	MIN	TYP
PldB	Output Power at 1 dB Compression VDS= 5.0 V Idss= 0.6 IDS=35mA	12 GHz	dBm	18.0	20.0
SSG	Small Signal Gain VDS= 5.0 V Idss= 0.6 IDS=35mA	12 GHz	dB	10.0	11.0
NFopt	Optimum Noise Figure VDS= 3.0V IDS= 10mA	12 GHz	dΒ		2.0
GA	Gain at Optimum Noise Figure VDS= 3.0V IDS= 10mA	12 GHz	dB		8.0
IDSS	Recommended IDSS Range for Optimum Pl dB		mA		50- 86

VALUE

DEVICE EQUIVALENT CIRCUIT MODEL

0-	Lg	Rg 	Cgd	Rd W	Ld	
GATE	Cpg =	Cgs — Ri ≷	gm tau	Rds Cds	_ Cpd	DRAIN
			Rs			
			Ls &			
			SOURCE _		ti e	

			T. C. C.	
Source Resistance	Rs	2.6	Ω	7
Source Inductance	Ls	0.025	nН	
Drain-Source Resistance	Rds	173	Ω	
Drain-Source Capacitance	Cds	0.07	pF	
Drain Resistance	Rd	3.67	Ω	
Drain Pad Capacitance	Cpd	0.027	pF	
Drain Inductance	Ld	0.159	nH	
Gate Bond Wire Inductance	Lg	0.89	nН	
Gate Pad Capacitance	Cpg	0.05	pF	
Gate Resistance	Rg	0.2	Ω	
Gate-Source Capacitance	Cgs	0.314	pF	
Channel Resistance	Ri	6.9	Ω	
Gate-Drain Capacitance	Cgd	0.027	pF	
Transconductance	gm	69.0	mS	
Transit Time	tau	3.02	psec	

ORDERING INFORMATION

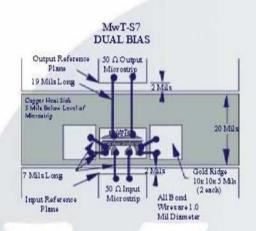
 Chip
 MwT-7
 NOTE:

 Package 71
 MwT-771
 For Package

Package 71 MwT-771 For Package information, please see supplimentary application note from our website at
Www.mwtinc.com. When placing order or inquiring, please specify BIN range, wafer no., if
known, and screening level required.

4268 Solar Way, Fremont, CA 94538 | Email sales@mwtinc.com | Phone (510) 651-6700 | Fax (510) 952-4000







150.0 125 100 75°C or Lower 100.0 125 100 25 C or Lower 100.0 125 100 75°C or Lower 10

Absolute Maximum Continuous Maximum

MAXIMUM RATINGS AT Ta = 25°C

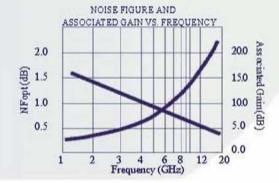
SYMBOL	PARAMETER	UNITS	CONTMAX	ABSOLUTE MAX1
VDS	Drain to Source Voltage	V	See Safe Ope	rating Limits
Tch	Channel Temperature	°C	+150	+175
Tst	Storage Temperature	°C	-65 to +150	+175
Pin	RF Input Power	mW	80	120

NOTES: 1. Exceeding any one of these limits in continuous operation may reduce the mean-time-to-failure below the design goals.

2. Exceeding any one of these limits may cause permanent damage.

TYPICAL NOISE PARAMETERS MwT-A9LN Ghip: VDS= 3.0V IDS= 35mA

FREQUENCY	NF MIN	GAM?			
GHz	dB	MAG	ANGLE	Rn/50	
2,00	0.29	0.68	27	0.188	
4.00 8.00	0.56 1.06	0.49	57 11.4	0.182	
12.00	1.5	0.49	149 168	0.152	
18.00	2.1	0.58	175	0.14	



Bin Selection Guide

Bin	Α	В	С	D
Idss	26-	38-	50-	74-
Range	38	50	74	86

BIN ACCURACY STATEMENT

When placing order or inquiring, please specify BIN range, wafer no., if known, and screening level required.